

N-Channel 20V (D-S) MOSFET

V_{DSS}	$R_{DS(on)}\text{MAX}$	I_D
20V	0.060Ω@4.5V	4A
	0.115Ω@2.5V	

Features

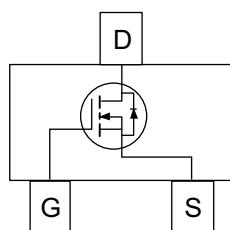
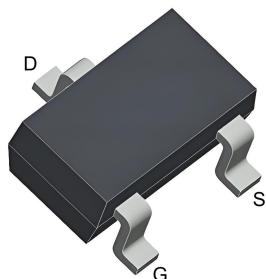
- Low Gate Charge
- RoHS Compliant

Applications

- Load Switch
- Power management

Pin Configuration

SOT23-3L



Packing Information

Device	Marking	Reel Size	Tape Width	Quantity
ECG2302	MPCS	7"	8mm	3000pcs

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

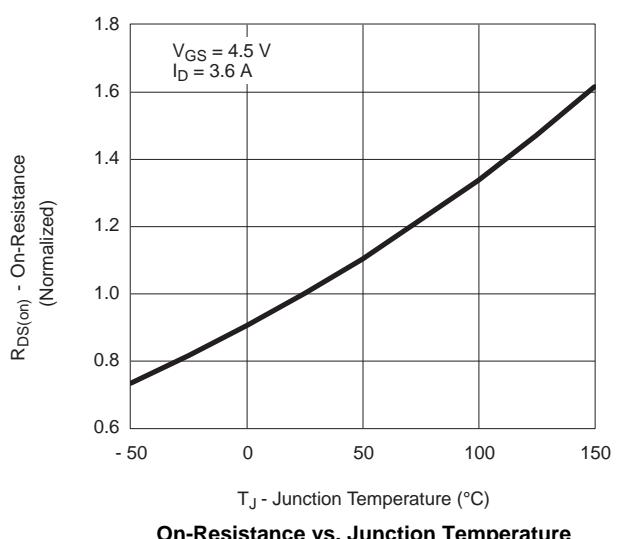
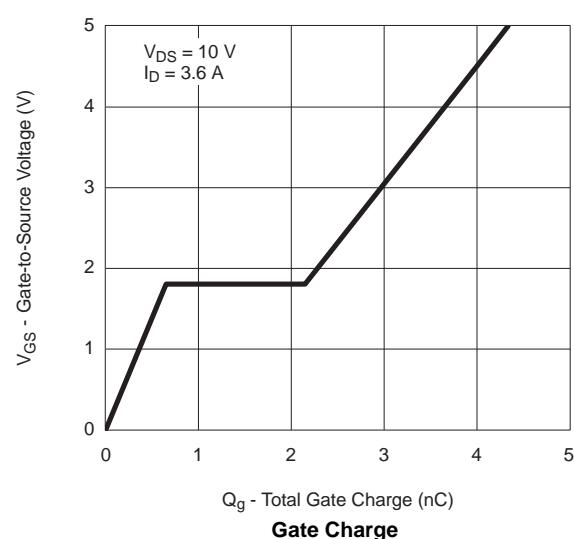
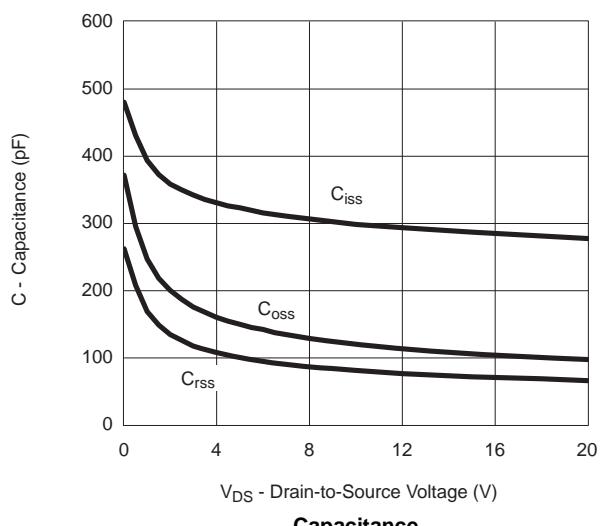
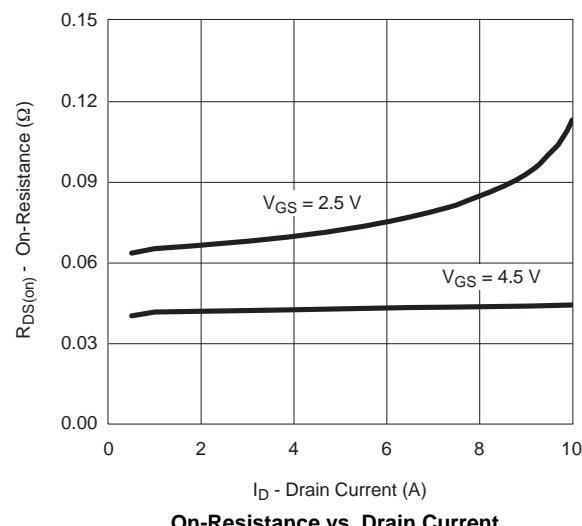
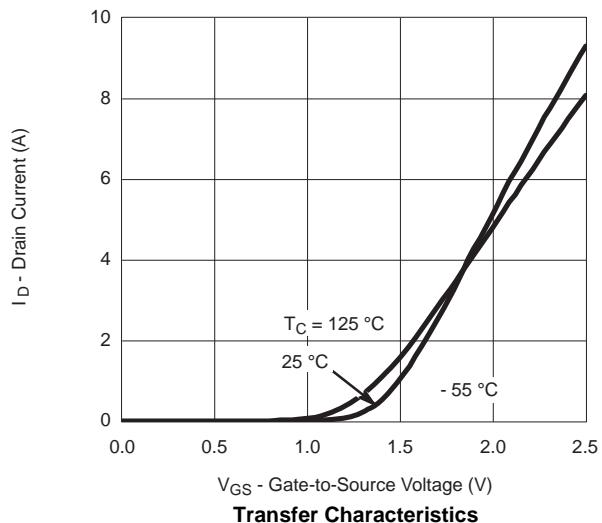
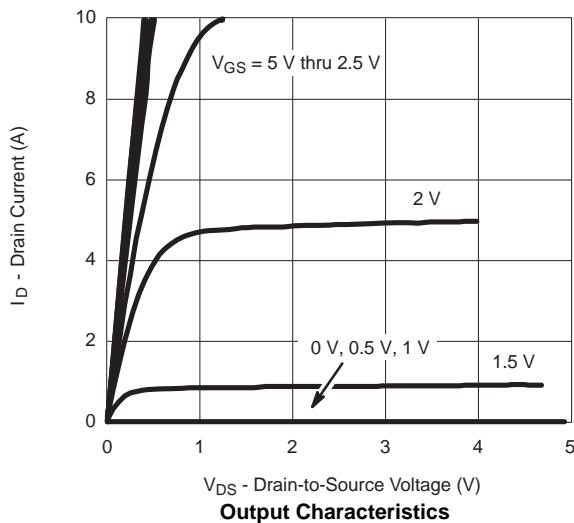
Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	±8	V
I_D	Drain Current -Continuous	4	A
I_{DM}	Drain Current - Pulse	15	A

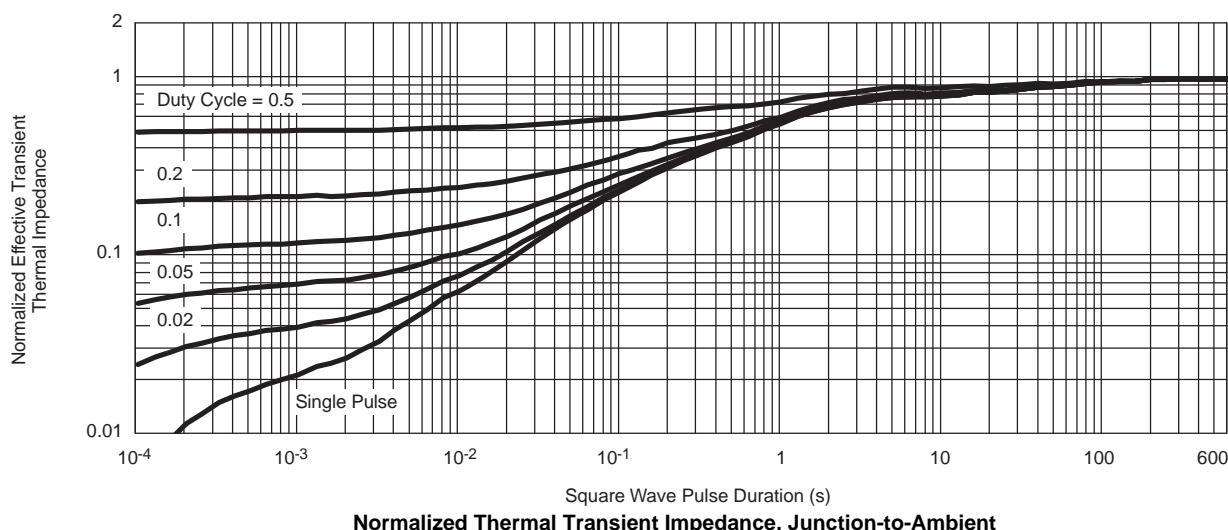
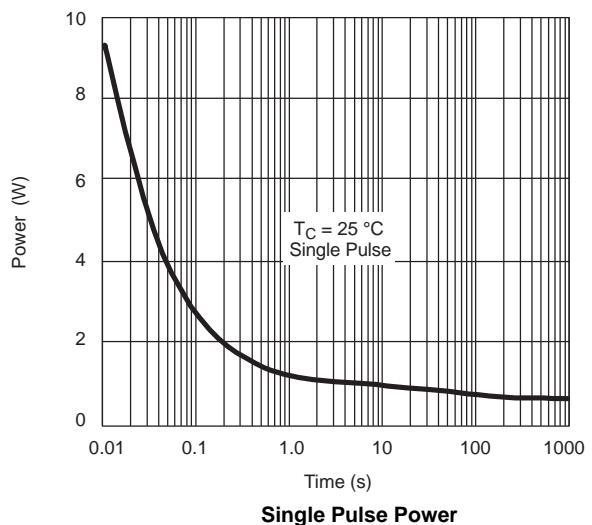
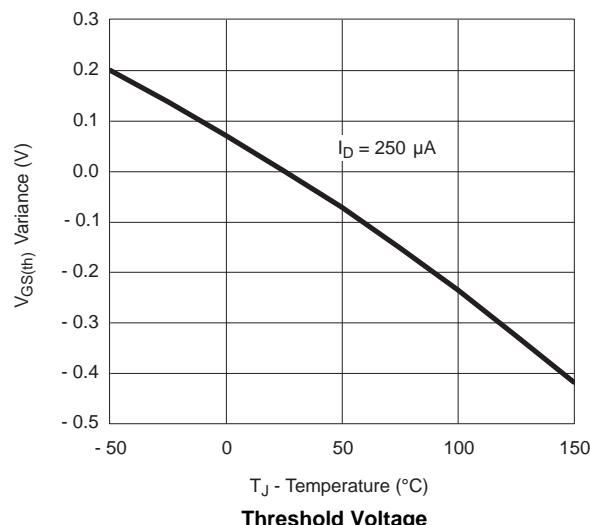
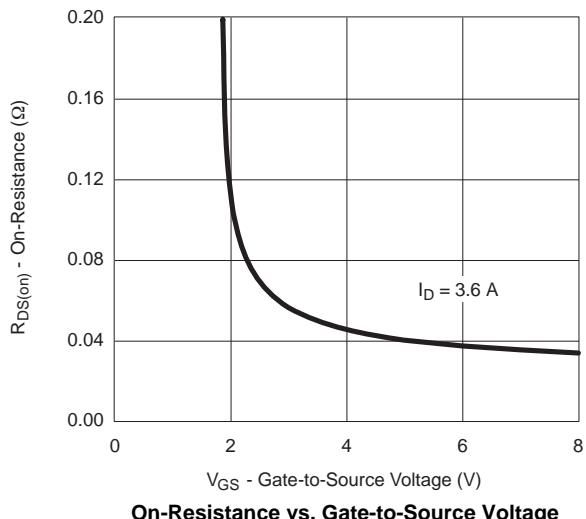
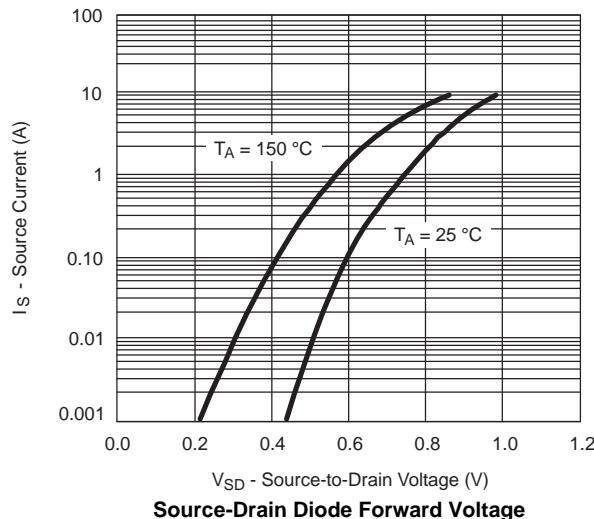
Power Dissipation, Temperature and Thermal Resistance

P_D	Power Dissipation	0.9	W
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient (note1)	100	°C/W
	Thermal Resistance from Junction to Ambient (note2)	140	°C/W
T_j	Junction Temperature	150	°C
T_{stg}	Storage Temperature	-55~+150	°C
T_L	Lead Temperature	260	°C

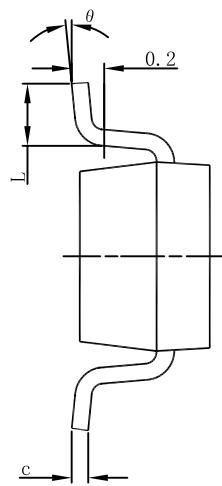
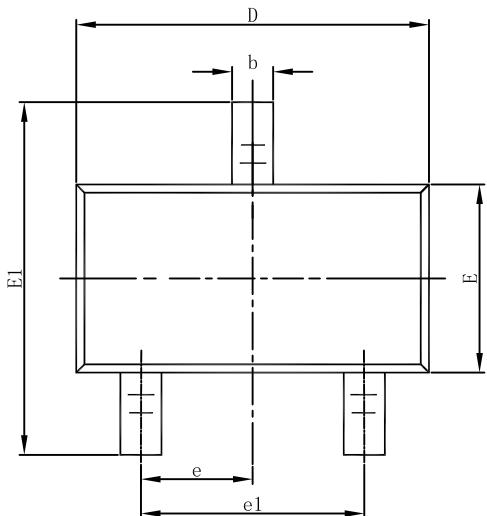
N-ch MOSFET ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	20			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 8\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	0.65	0.95	1.20	V
Drain-source on-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 3.5\text{A}$		45	60	$\text{m}\Omega$
		$V_{\text{GS}} = 2.5\text{V}, I_D = 3.1\text{A}$		70	115	$\text{m}\Omega$
Diode forward voltage	V_{SD}	$I_S = 1.0\text{A}, V_{\text{GS}} = 0\text{V}$		0.6	1.2	V
Dynamic						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		300		pF
Output Capacitance	C_{oss}			120		
Reverse Transfer Capacitance	C_{rss}			80		
Total Gate Charge	Q_g	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 4.5\text{V}, I_D = 3.6\text{A}$		4.0	10	nC
Gate-Source Charge	Q_{gs}			0.65		
Gate-Drain Charge	Q_{gd}			1.5		
Gate Resistance	R_g	$f = 1\text{MHz}$	0.5	1.0	2.0	Ω
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 10\text{V}, R_L = 2.8\Omega$ $I_D \geq 3.6\text{A}, V_{\text{GEN}} = 4.5\text{V}, R_g = 6\Omega$		7	15	ns
Rise Time	t_r			55	80	
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			16	60	
Fall Time	t_f			10	25	

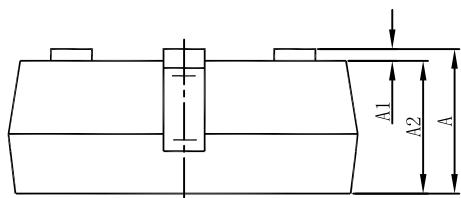
MOSFET TYPICAL CHARACTERISTICS(25°C, unless otherwise noted)


MOSFET TYPICAL CHARACTERISTICS(25°C, unless otherwise noted)


SOT23-3L Package Information



Top View



Side View

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°